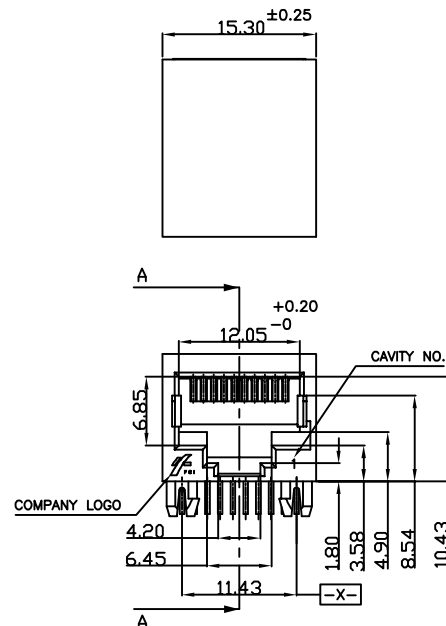
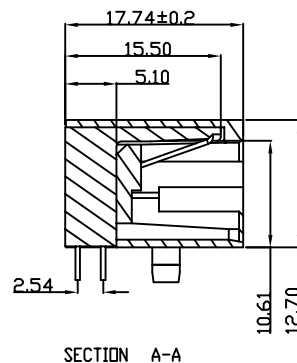
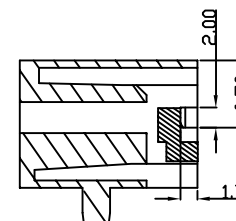
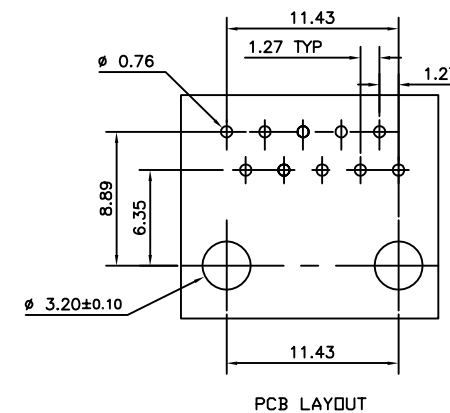
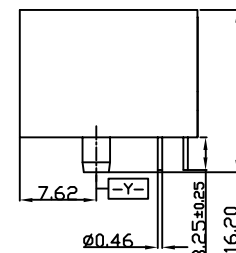


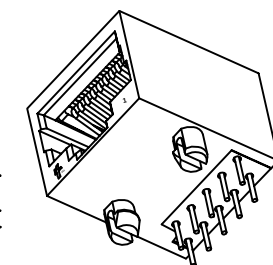


- 1.LF Products meet European Union Directives and other country Regulations as described in GS-22-008.
- 2.The Housing will withstand exposure to 260° peak temperature for 3.5 sec in a wave solder application with a 1.6mm Min thick circuit board. Slight deformation of snap pegs may occur at 260-265°c which will not affect the function of the product.
- 3.Lead Free or ROHS Directive labelling to be provided as per GS-14-920 for Lead Free version.



PART NO. 54602-X10 LF

LEAD FREE
6-0.76 µ Au.Sel.
7-Au Flash.Sel.
8-1.27 µ Au.Sel.
9-0.38 µ Au.Sel.



SECTION B-B

NOTES:

1. ALL WIRES MUST BE STRAIGHT TO THE SHELF

mat'l. code -				surface ISO 1302 ✓		tolerance ISO 406 ISO 1101		projection 		product family MODJACK			
ltr	ecn no	dr	date	tolerances unless otherwise specified		angles		linear		title			
D	I06-0123	HVN	2006-07-21			±0.1				10 POL SHALLOW LATCH CONNECTOR			
E	I07-0039	HVN	2007-03-16							(PCB.MODJACK)			
F	I07-0122	HVN	2007-09-19			±1°				scale -			
				dr	MINI K VANDANATH	2003-04-04			dwg no		sheet 1 of 1		size
				engr	HIRAN.V.N	2003-04-04			C-BMJ-0101		A3		
				chr	HIRAN.V.N	2007-09-19							
				appd	HIRAN.V.N	2007-09-19			type		Product	Customer	Drawing
sheet index		revision sheet		F	1								